

## SinglFuse™ SF-1206S Series Features

- Single blow fuse for overcurrent protection
- 3216 (EIA 1206) miniature footprint
- Slow blow fuse
- UL listed
- RoHS compliant\* and halogen free\*\*
- Thin film chip fuse
- Surface mount packaging for automated assembly

## SF-1206S Series - Slow Blow Surface Mount Fuses

### Electrical Characteristics

Model	Rated Current (Amps)	Fusing Time	Resistance (mΩ) Typ.***	Rated Voltage	Breaking Capacity	Typical I <sup>2</sup> t (A <sup>2</sup> s)
SF-1206S050	0.50	Open within 5 sec. at 250 % rated current	385	DC 63 V	DC 63 V 50 A	0.030
SF-1206S080	0.80		165			0.068
SF-1206S100	1.00		108			0.098
SF-1206S125	1.25		76			0.155
SF-1206S150	1.50		51			0.236
SF-1206S200	2.00		32	DC 32 V	DC 32 V 50 A	0.339
SF-1206S250	2.50		26			0.605
SF-1206S300	3.00		20	DC 24 V	DC 24 V 50 A	0.933
SF-1206S400	4.00		14			1.537
SF-1206S500	5.00		10			2.533
SF-1206S700	7.00	6.5	5.684			

\*\*\*Resistance value was measured with less than 10 % of rated current.

### Reliability Testing

Parameter	Requirement	Test Method
Carrying Capacity	No fusing	Rated current, 4 hours
Fusing Time	Within 5 seconds	250 % of its rated current
Interrupting Ability	No mechanical damages	After the fuse is interrupted, rated voltage applied for 30 seconds again
Bending Test	No mechanical damages	Distance between holding points: 90 mm, Bending: 3 mm, 1time, 30 seconds
Resistance to Solder Heat	±20 %	260 °C ±5 °C, 10 seconds ±1 second
Solderability	95 % coverage minimum	235 °C ±5 °C, 2 ±0.5 second 245 °C ±5 °C, 2 ±0.5 second (lead free)
Temperature Rise	<75 °	100 % of its rated current, measure of surface temperature
Resistance to Dry Heat	±20 %	105 °C ±5 °C, 1000 hours
Resistance to Solvent	No evident damage on protective	23 °C ±5 °C of isopropyl alcohol, 90 seconds coating and marking
Residual Resistance	10k W or more	Measure DC resistance after fusing
Thermal Shock	DR < 10 %	-20 °C / +25 °C / +125 °C / +25 °C, 10 cycles

### Typical Part Marking

Represents total content. Layout may vary.



RATING CURRENT (A)	
F = 0.50	T = 2.50
K = 0.80	3 = 3.00
L = 1.00	W = 4.00
M = 1.25	Y = 5.00
P = 1.50	Z = 7.00
S = 2.00	

### How to Order

**SF - 1206 S 050 - 2**

SinglFuse™	Product Designator
SMD Footprint	3216 (EIA 1206) size
Fuse Blow Type	F = Fast acting S = Slow blow
Rated Current	050-700 (500 mA - 7.00 A)
Packaging Type	- 2 = Tape & Reel (5,000 pcs./reel)

**BOURNS®**

#### Asia-Pacific:

Tel: +886-2 2562-4117  
Fax: +886-2 2562-4116

#### Europe:

Tel: +41-41 768 5555  
Fax: +41-41 768 5510

#### The Americas:

Tel: +1-951 781-5500  
Fax: +1-951 781-5700

[www.bourns.com](http://www.bourns.com)

\* RoHS Directive 2002/95/EC Jan 27 2003 including Annex.

\*\* Bourns is using the definition that appears to be the prevalent definition used as the industry standard at this time. The Bourns definition of "halogen-free" is: Bromine (Br) content: ≤ 900 ppm; Chlorine (Cl) content: ≤ 900 ppm; Total Br + Cl content: ≤ 1500 ppm.

"SinglFuse" is a trademark of Bourns, Inc.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

# SinglFuse™ SF-1206S Series Applications

- Portable memory
- LCD monitors
- Disk drives
- PDAs
- Digital cameras
- DVDs
- Cell phones
- Rechargeable battery packs
- Battery chargers
- Set top boxes
- Industrial controllers

## SF-1206S Series - Slow Blow Surface Mount Fuses BOURNS®

### Solder Reflow Recommendations



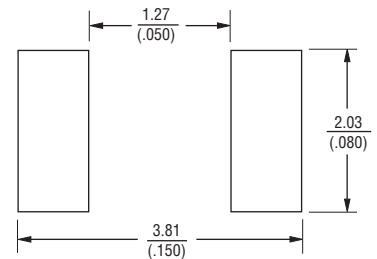
PEAK: 250 +0/-5 °C, 5 seconds  
 PRE-HEATING ZONE: 150 to 180 °C, 90 ± 30 seconds  
 SOLDERING ZONE: 230 °C or higher, 30 ± 10 seconds

### Product Dimensions



PACKAGING: 5,000 pcs./reel

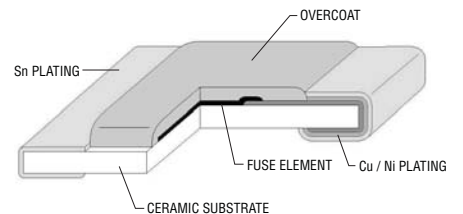
### Recommended Pad Layout



### Thermal Derating Curve



### Construction & Material Content



Operating Temperature.....-40 °C to +105 °C  
 Storage Conditions  
 Temperature .....+5 °C to +35 °C  
 Humidity.....40 % to 75 %  
 Shelf Life..... 2 years from manufacturing date

Specifications are subject to change without notice.  
 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
 Users should verify actual device performance in their specific applications.

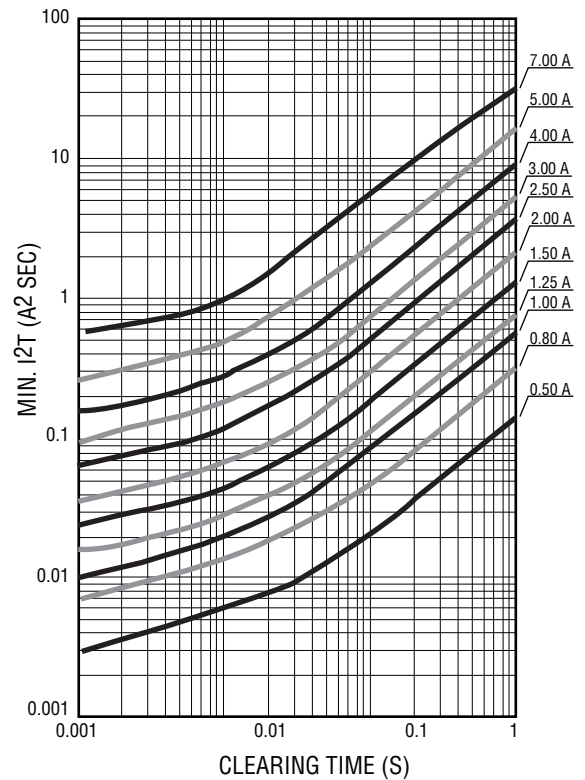
# SF-1206S Series - Slow Blow Surface Mount Fuses



Average Time Current Curves



Minimum I<sup>2</sup>T V Clear Time Curves



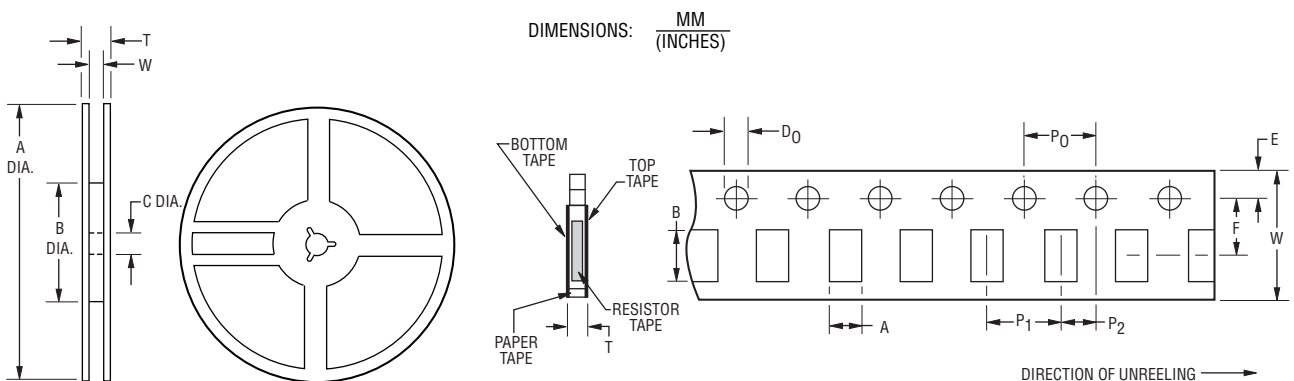
REV. D 03/13

Specifications are subject to change without notice.  
 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
 Users should verify actual device performance in their specific applications.

# SF-1206S Series Tape and Reel Specifications

# BOURNS®

Tape Dimensions	SF-1206S Series per EIA 481-2
W	$\frac{8.0 \pm 0.2}{(.315 \pm .008)}$
P <sub>0</sub>	$\frac{4.0 \pm 0.1}{(.157 \pm .004)}$
P <sub>1</sub>	$\frac{4.0 \pm 0.1}{(.157 \pm .004)}$
P <sub>2</sub>	$\frac{2.0 \pm 0.05}{(.079 \pm .002)}$
A	$\frac{2.0 \pm 0.15}{(.079 \pm .006)}$
B	$\frac{3.6 \pm 0.2}{(.142 \pm .008)}$
F	$\frac{3.5 \pm 0.05}{(.138 \pm .002)}$
E	$\frac{1.75 \pm 0.1}{(.069 \pm .004)}$
D <sub>0</sub>	$\frac{1.5 + 0.1/-0}{(.059 + .004/-0)}$
T	$\frac{0.84 \pm 0.1}{(.033 \pm .004)}$
<b>Reel Dimensions</b>	
A	$\frac{180 +0/-3.0}{(7.087 +0/-118)}$
B Min.	$\frac{60.0}{(2.362)}$
C	$\frac{13.0 \pm 1.0}{(.512 \pm .039)}$
W	$\frac{9.0 \pm 1.0}{(.354 \pm .039)}$
T	$\frac{11.4 \pm 2.0}{(.449 \pm .079)}$



Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
Users should verify actual device performance in their specific applications.

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9